

HAT2044R

Silicon N Channel Power MOS FET
Power Switching

HITACHI

ADE-208-722A (Z)
2nd Edition
February 1999

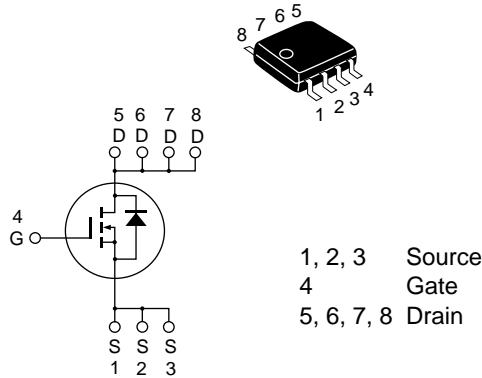
Features

- Capable of 2.5 V gate drive
- Low drive current
- High density mounting
- Low on-resistance

$$R_{DS(on)} = 6.5 \text{ m}\Omega \text{ typ} \quad (\text{at } V_{GS} = 4.5\text{V})$$

Outline

SOP-8



Absolute Maximum Ratings (Ta = 25°C)

Item	Symbol	Ratings	Unit
Drain to source voltage	V_{DSS}	30	V
Gate to source voltage	V_{GSS}	± 12	V
Drain current	I_D	15	A
Drain peak current	$I_{D(pulse)}$ ^{Note1}	120	A
Body-drain diode reverse drain current	I_{DR}	15	A
Channel dissipation	Pch ^{Note2}	2.5	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	- 55 to + 150	°C

Note: 1. $PW \leq 10 \mu s$, duty cycle $\leq 1\%$

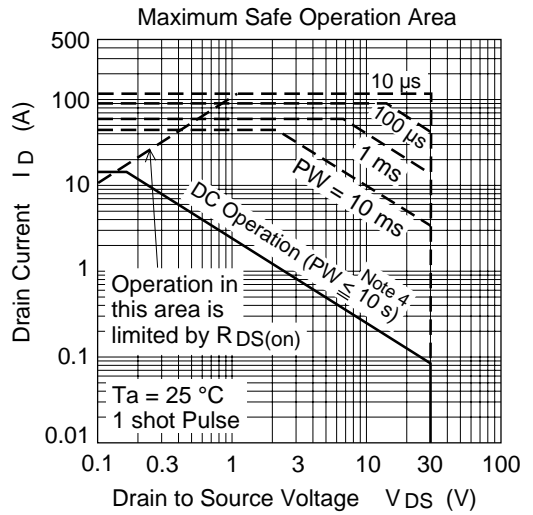
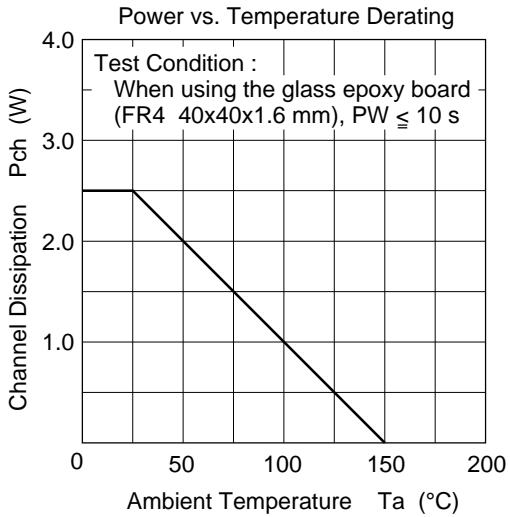
2. When using the glass epoxy board (FR4 40 x 40 x 1.6 mm), $PW \leq 10s$

Electrical Characteristics (Ta = 25°C)

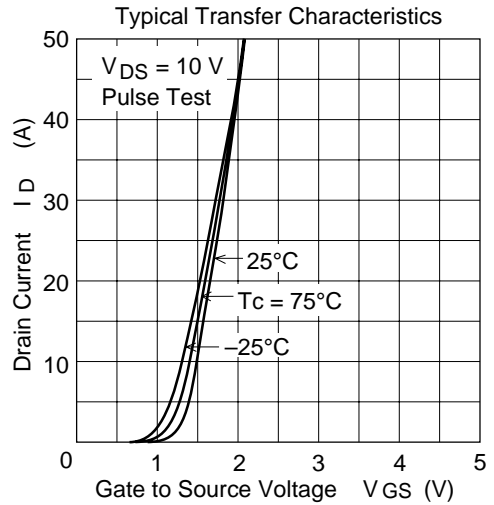
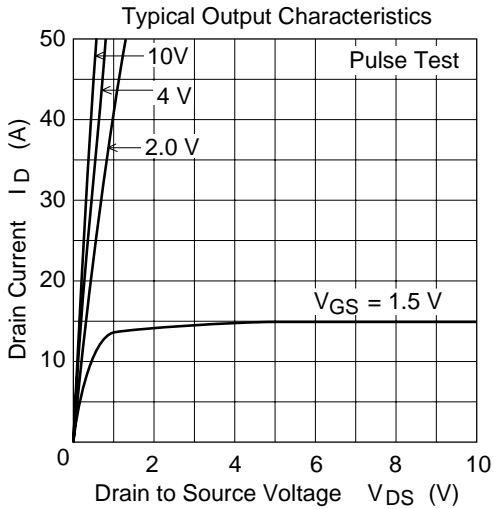
Item	Symbol	Min	Typ	Max	Unit	Test Conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	30	—	—	V	$I_D = 10 \text{ mA}$, $V_{GS} = 0$
Gate to source leak current	I_{GSS}	—	—	± 0.1	μA	$V_{GS} = \pm 12 \text{ V}$, $V_{DS} = 0$
Zero gate voltage drain current	I_{DSS}	—	—	1	μA	$V_{DS} = 30 \text{ V}$, $V_{GS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	0.4	—	1.4	V	$V_{DS} = 10 \text{ V}$, $I_D = 1 \text{ mA}$
Static drain to source on state resistance	$R_{DS(on)}$	—	6.5	9.0	$m\Omega$	$I_D = 8 \text{ A}$, $V_{GS} = 4.5 \text{ V}$ ^{Note3}
	$R_{DS(on)}$	—	7.0	9.5	$m\Omega$	$I_D = 8 \text{ A}$, $V_{GS} = 4.0 \text{ V}$ ^{Note3}
	$R_{DS(on)}$	—	9.0	13.0	$m\Omega$	$I_D = 8 \text{ A}$, $V_{GS} = 2.5 \text{ V}$ ^{Note3}
Forward transfer admittance	$ y_{fs} $	24	40	—	S	$I_D = 8 \text{ A}$, $V_{DS} = 10 \text{ V}$ ^{Note3}
Input capacitance	Ciss	—	3420	—	pF	$V_{DS} = 10 \text{ V}$
Output capacitance	Coss	—	950	—	pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss	—	480	—	pF	$f = 1 \text{ MHz}$
Total gate charge	Qg	—	48	—	nc	$V_{DD} = 10 \text{ V}$
Gate to source charge	Qgs	—	32	—	nc	$V_{GS} = 4 \text{ V}$
Gate to drain charge	Qgd	—	16	—	nc	$I_D = 15 \text{ A}$
Turn-on delay time	$t_{d(on)}$	—	45	—	ns	$V_{GS} = 4 \text{ V}$, $I_D = 8 \text{ A}$
Rise time	t_r	—	285	—	ns	$V_{DD} \cong 10 \text{ V}$
Turn-off delay time	$t_{d(off)}$	—	470	—	ns	
Fall time	t_f	—	360	—	ns	
Body-drain diode forward voltage	V_{DF}	—	0.85	1.1	V	$IF = 15 \text{ A}$, $V_{GS} = 0$ ^{Note3}
Body-drain diode reverse recovery time	t_{rr}	—	45	—	ns	$IF = 15 \text{ A}$, $V_{GS} = 0$ $diF/dt = 20 \text{ A}/\mu s$

Note: 3. Pulse test

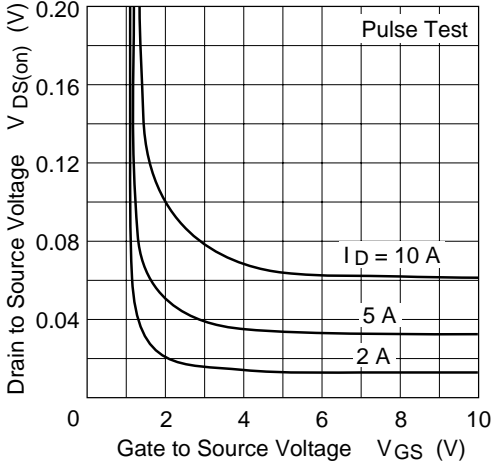
Main Characteristics



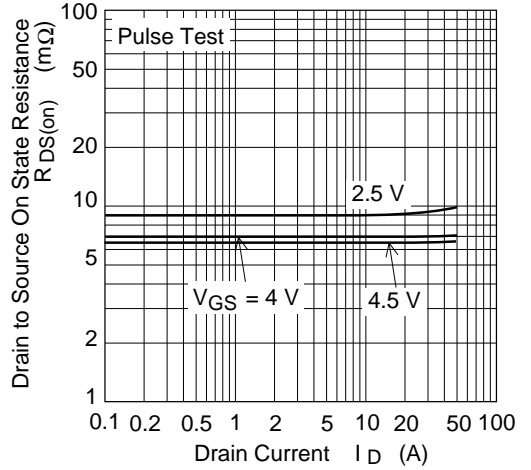
Note 4 :
When using the glass epoxy board (FR4 40x40x1.6 mm)



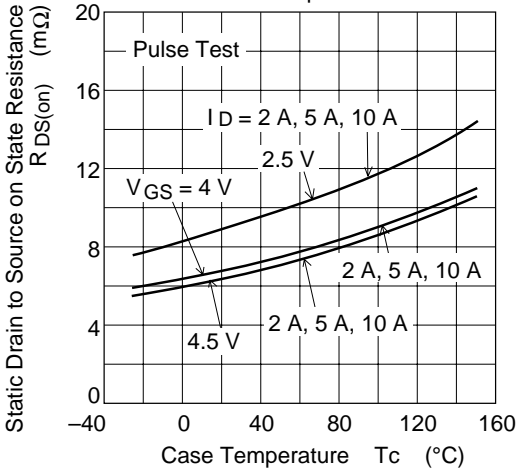
Drain to Source Saturation Voltage vs. Gate to Source Voltage



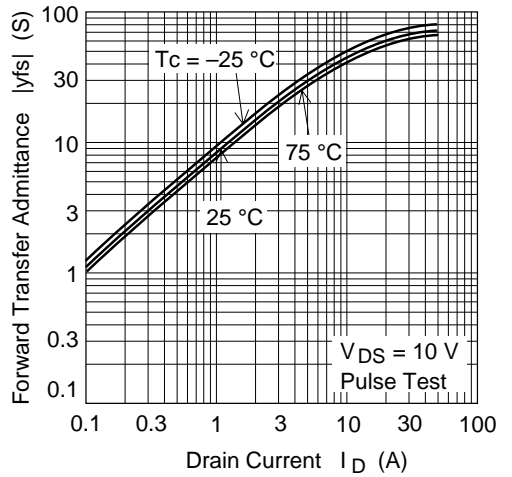
Static Drain to Source on State Resistance vs. Drain Current

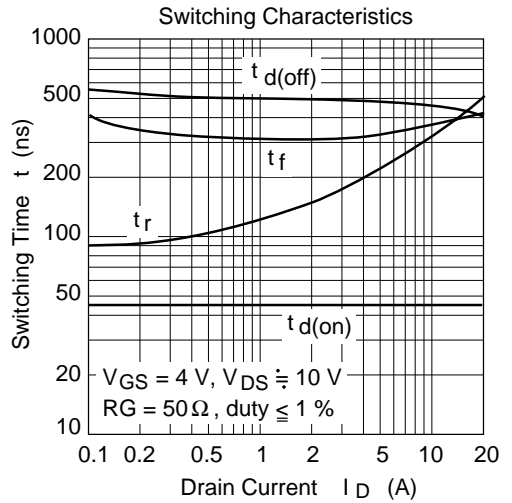
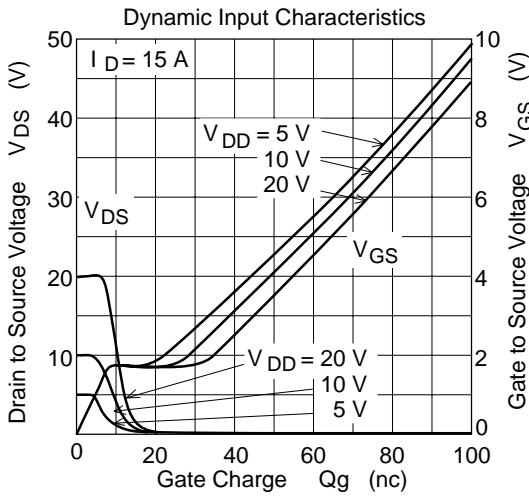
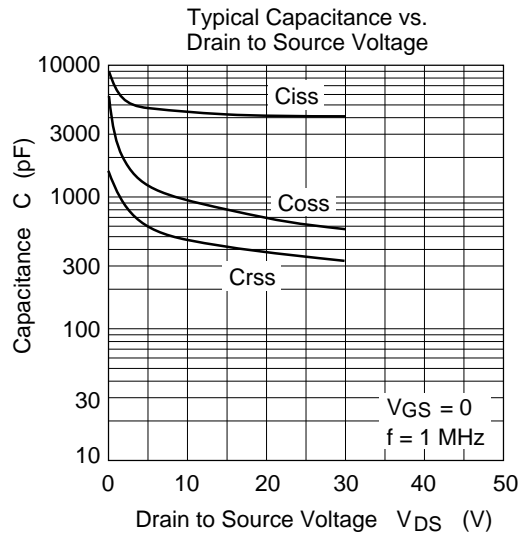
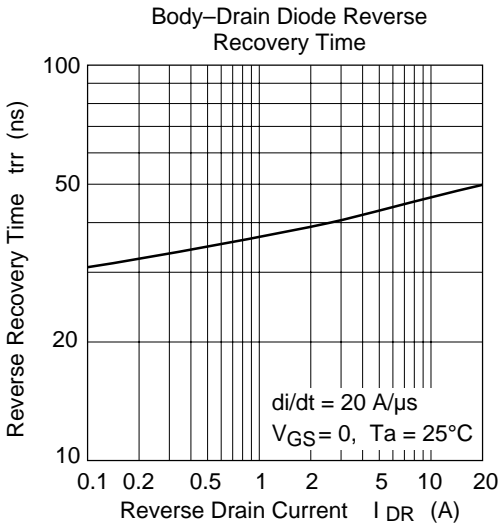


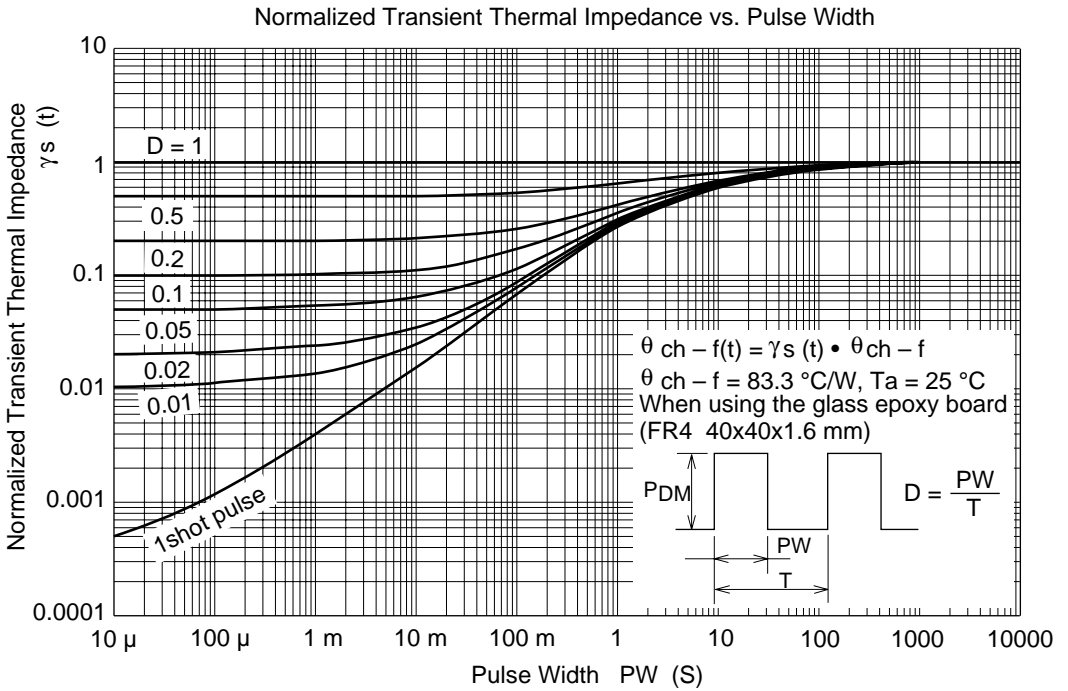
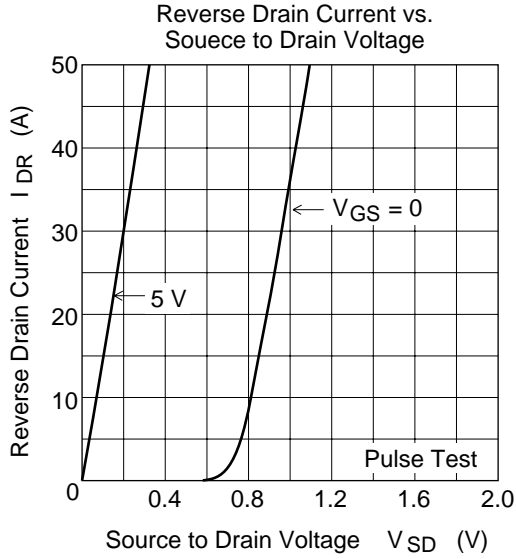
Static Drain to Source on State Resistance vs. Temperature



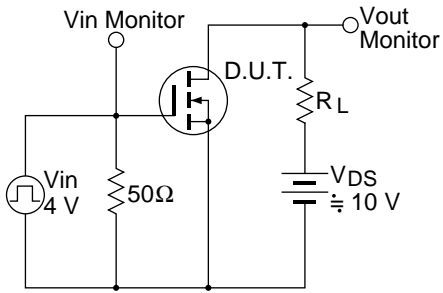
Forward Transfer Admittance vs. Drain Current



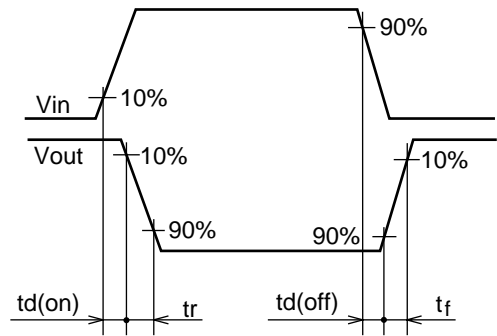




Switching Time Test Circuit

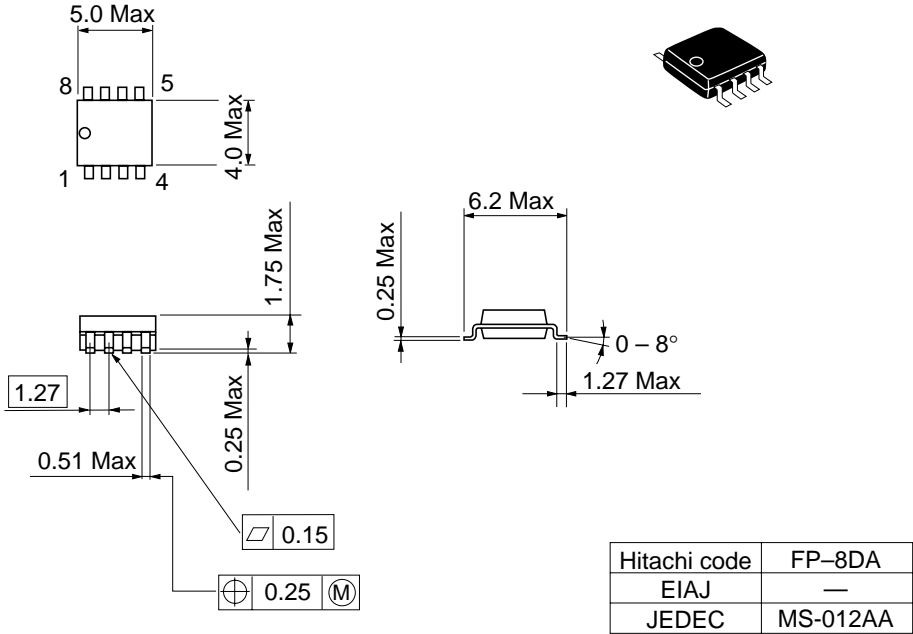


Switching Time Waveform



Package Dimensions

Unit: mm



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